Single Channel Operational Amplifier

LM321

LM321 is a general purpose, single channel op amp with internal compensation and a true differential input stage. This op amp features a wide supply voltage ranging from 3 V to 32 V for single supplies and ± 1.5 to ± 16 V for split supplies, suiting a variety of applications. LM321 is unity gain stable even with large capacitive loads up to 1.5 nF. LM321 is available in a space-saving TSOP-5/SOT23-5 package.

Features

- Wide Supply Voltage Range: 3 V to 32 V
- Short Circuit Protected Outputs
- True Differential Input Stage
- Low Input Bias Currents
- Internally Compensated
- Single and Split Supply Operation
- Unity Gain Stable with 1.5 nF Capacitive Load
- This Device is Pb-Free, Halogen Free/BFR Free and is RoHS Compliant

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Typical Applications

- Gain Stage
- Active Filter
- Signal Processing

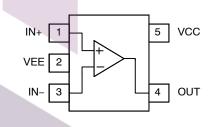


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MARKING DIAGRAM



ADY = Specific Device Code

- A = Assembly Location
- Y = Year W = Work
- W = Work Week = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|-------------|---------------------|-----------------------|
| LM321SN3T1G | TSOP-5 (Pb-Free) | 3000 / Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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Table 1. ABSOLUTE MAXIMUM RATINGS (Over operating free-air temperature, unless otherwise stated)

| Parameter | Rating | Unit |
|--|-----------------------------|------|
| Supply Voltage | 36 | V |
| INPUT AND OUTPUT PINS | | |
| Input Voltage | V _{EE} – 0.3 to 32 | V |
| Input Current | ±10 | mA |
| Output Short Circuit Duration (Note 1) | Continuous | |
| TEMPERATURE | | |
| Operating Temperature | -40 to +125 | °C |
| Storage Temperature | -65 to +150 | °C |
| Junction Temperature | -65 to +150 | °C |
| ESD RATINGS (Note 2) | | |
| Human Body Model (HBM) | 200 | V |
| Charged Device Model (CDM) | 800 | V |
| Machine Model (MM) | 100 | V |
| OTHER RATINGS | | |
| Latch-Up Current (Note 3) | 100 | mA |
| MSL | Level 1 | |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Short circuits can cause excessive heating and eventual destruction.

 This device series incorporates ESD protection and is tested by the following methods: ESD Human Body Model tested per JEDEC standard: JESD22-A114 ESD Machine Model tested per JEDEC standard: JESD22-A115

Latch-up Current tested per JEDEC standard: JESD78

Table 2. THERMAL INFORMATION (Note 4)

| Parameter | Symbol | Package | Value | Unit |
|---------------------|---------------|----------------|-------|------|
| Junction to Ambient | θ_{JA} | TSOP-5/SOT23-5 | 235 | °C/W |

4. As mounted on an 80 × 80 × 1.5 mm FR4 PCB with 650 mm² and 2 oz (0.034 mm) thick copper heat spreader. Following JEDEC JESD/EIA 51.1, 51.2, 51.3 test guidelines.

Table 3. RECOMMENDED OPERATING CONDITIONS

| Parameter | Symbol | Range | Unit |
|---|-----------------|---|------|
| Supply Voltage (V _{CC} - V _{EE}) | Vs | 3 to 32 | V |
| Specified Operating Range | T _A | -40 to 85 | °C |
| Common Mode Input Voltage Range | V _{CM} | V _{EE} to V _{CC} -1.7 | V |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.



Table 4. ELECTRICAL CHARACTERISTICS – $V_S = 5 V$

(At $T_A = +25^{\circ}$ C, $R_L = 10 \text{ k}\Omega$ connected to mid-supply, $V_{CM} = V_{OUT}$ = mid-supply, unless otherwise noted. **Boldface** limits apply over the specified temperature range, $T_A = -40^{\circ}$ C to 85°C, guaranteed by characterization and/or design.)

| Parameter | Symbol | Conditions | Min | Тур | Мах | Unit |
|------------------------------|----------------------------|--|--|--|----------------------|--------|
| INPUT CHARACTERISTICS | | | • | | | |
| Offset Voltage | V _{OS} | $V_{S} = 5 V, V_{CM} = V_{EE} \text{ to } V_{CC} - 1.7 V$ $T_{A} = 25^{\circ}C$ $T_{A} = -40^{\circ}C \text{ to } 85^{\circ}C$ | | 0.3 - | 7 9 | mV |
| Offset Voltage Drift vs Temp | $\Delta V_{OS} / \Delta T$ | $T_A = -40^{\circ}C$ to $85^{\circ}C$ | - | 7 | - | μV/°C |
| Input Bias Current | I _{IB} | $T_A = 25^{\circ}C$ $T_A = -40^{\circ}C$ to $85^{\circ}C$ | | -10 - | _ -500 | nA |
| Input Offset Current | I _{OS} | $T_A = 25^{\circ}C$ $T_A = -40^{\circ}C$ to $85^{\circ}C$ | - | 1 - | _ 150 | nA |
| Common Mode Rejection Ratio | CMRR | $V_{CM} = V_{EE}$ to $V_{CC} - 1.7$ V | 65 | 85 | - | dB |
| Input Resistance | R _{IN} | Differential Common Mode | - | 85 300 | | GΩ |
| Input Capacitance | C _{IN} | Differential Common Mode | | 0.6 1.6 | | pF |
| OUTPUT CHARACTERISTICS | | | | | | |
| Open Loop Voltage Gain | A _{VOL} | | - | 100 | - | dB |
| Open Loop Output Impedance | Z _{OUT_OL} | f = UGBW, I _O = 0 mA | - | 1,200 | - | Ω |
| Output Voltage High | V _{OH} | $R_L = 2 k\Omega$ to V_{EE} $R_L = 10 k\Omega$ to V_{EE} | V _{CC} -1.8 V _{CC} -1.8 | V _{CC} -1.4 V _{CC} -1.4 | | V |
| Output Voltage Low | V _{OL} | R_L = 10 k Ω to V _{CC} | - | V _{EE} +0.8 | V _{EE} +1.0 | V |
| Output Current Capability | Ι _Ο | Sinking Current $V_S = 5 V$ $V_S = 15 V$ | 10 10 | 20 20 | - - | mA |
| Output Current Capability | IO | Sourcing Current $V_S = 5 V$ $V_S = 15 V$ | 20 20 | 40 40 | | mA |
| Capacitive Load Drive | CL | Phase Margin = 15° | - | 1,500 | - | pF |
| NOISE PERFORMANCE | | | | | | |
| Voltage Noise Density | e _N | f _{IN} = 1 kHz | - | 40 | - | nV/√Hz |
| DYNAMIC PERFORMANCE | | | | | | |
| Gain Bandwidth Product | GBWP | $C_L = 25 \text{ pF}, \text{ R}_L \text{ to } \text{V}_{CC}$ | - | 750 | - | kHz |
| Gain Margin | A _M | $C_L = 25 \text{ pF}, \text{ R}_L \text{ to } \text{V}_{CC}$ | - | 14 | - | dB |
| Phase Margin | α _M | $C_L = 25 \text{ pF}, \text{ R}_L \text{ to } \text{V}_{CC}$ | - | 60 | - | 0 |
| Slew Rate | SR | $C_L = 25 \text{ pF, } R_L = \infty$ | - | 0.3 | - | V/µs |
| POWER SUPPLY | | | | | | |
| Power Supply Rejection Ratio | PSRR | V _S = 5 V to 32 V | 62 | 100 | - | dB |
| Quiescent Current | Ι _Q | No Load | _ | 0.25 | 0.5 | mA |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



Table 5. ELECTRICAL CHARACTERISTICS – $V_S = 32 V$

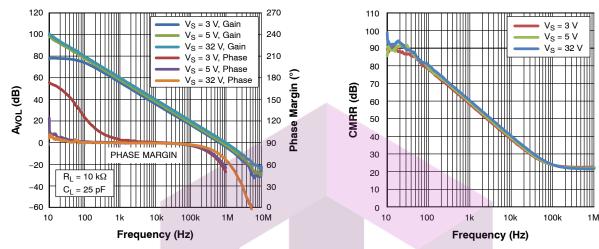
(At $T_A = +25^{\circ}$ C, $R_L = 10 \text{ k}\Omega$ connected to mid-supply, $V_{CM} = V_{OUT}$ = mid-supply, unless otherwise noted. **Boldface** limits apply over the specified temperature range, $T_A = -40^{\circ}$ C to 85°C, guaranteed by characterization and/or design.)

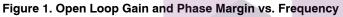
| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|--------------------------------------|----------------------------|---|--|--|----------------------|--------|
| INPUT CHARACTERISTICS | | | | | | • |
| Offset Voltage | V _{OS} | | | 0.3 - | 7 9 | mV |
| Offset Voltage Drift vs Temp | $\Delta V_{OS} / \Delta T$ | T _A =40°C to 85°C | - | 7 | - | μV/°C |
| Common Mode Rejection Ratio | CMRR | V_{CM} = V_{EE} to V_{CC} – 1.7 V | - | 100 | - | dB |
| OUTPUT CHARACTERISTICS | | | | | | |
| Open Loop Voltage Gain | A _{VOL} | $T_A = 25^{\circ}C$ $T_A = -40^{\circ}C \text{ to } 85^{\circ}C$ | 84 | 100 - | | dB |
| Open Loop Output Impedance | Z _{OUT_OL} | f = UGBW, I _O = 0 mA | - | 2,000 | - | Ω |
| Output Voltage High | V _{OH} | $R_L = 2 k\Omega$ to V _{EE} $R_L = 10 k\Omega$ to V _{EE} | V _{CC} -2.5 V _{CC} -2.5 | V _{CC} -2.0 V _{CC} -1.5 | | V |
| Output Voltage Low | V _{OL} | $R_L = 10 \text{ k}\Omega$ to V_{CC} | - | V _{EE} +1.0 | V _{EE} +1.5 | V |
| Capacitive Load Drive | CL | Phase Margin = 15° | - | 1,500 | - | pF |
| NOISE PERFORMANCE | | | | | | |
| Voltage Noise Density | e _N | f _{IN} = 1 kHz | - | 40 | - | nV/√Hz |
| Total Harmonic Distortion + Noise | THD+N | V_{S} = 30 V, f_{IN} = 1 kHz, R_{L} to V_{CC} | - | 0.02 | _ | % |
| DYNAMIC PERFORMANCE | | | | • | • | |
| Gain Bandwidth Product | GBWP | $C_L = 25 \text{ pF}, \text{ R}_L \text{ to } \text{V}_{CC}$ | - | 900 | - | kHz |
| Gain Margin | A _M | $C_L = 25 \text{ pF}, \text{ R}_L \text{ to } \text{V}_{CC}$ | - | 18 | - | dB |
| Phase Margin | α _M | $C_L = 25 \text{ pF}, \text{ R}_L \text{ to } \text{V}_{CC}$ | - | 66 | - | 0 |
| Slew Rate | SR | $C_L = 25 \text{ pF}, R_L = \infty$ | - | 0.4 | - | V/μs |
| POWER SUPPLY | | | | | | |
| Power Supply Rejection Ratio | PSRR | V _S = 5 V to 32 V | 62 | 100 | _ | dB |
| Quiescent Current | IQ | No Load, V _S = 32 V | - | 0.3 | 1.2 | mA |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



TYPICAL CHARACTERISTICS





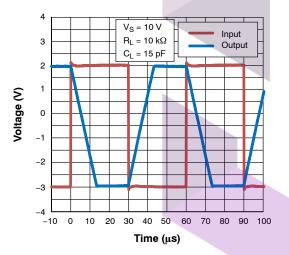


Figure 3. Inverting Large Signal Step Response

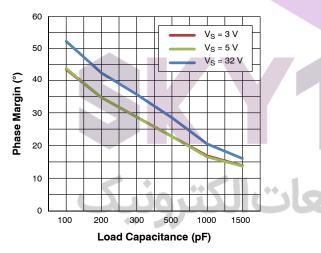
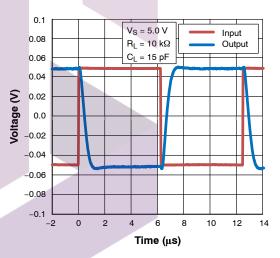


Figure 5. Phase Margin vs. Load Capacitance

Figure 2. CMRR vs. Frequency





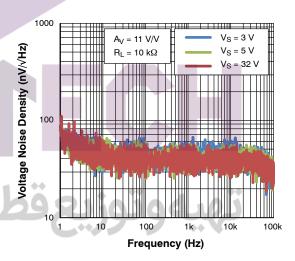


Figure 6. Voltage Noise Density vs. Frequency

TYPICAL CHARACTERISTICS

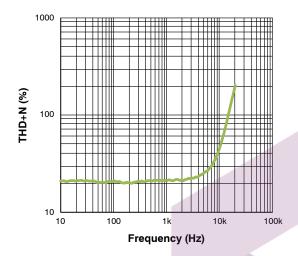
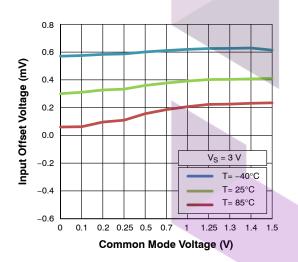
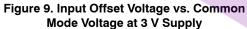
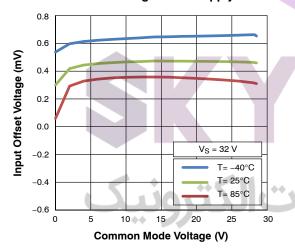
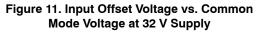


Figure 7. THD+N vs. Frequency









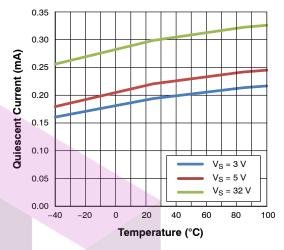


Figure 8. Quiescent Current vs. Temperature

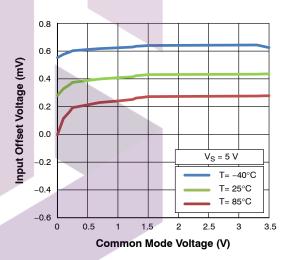
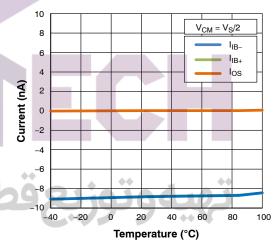
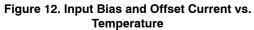
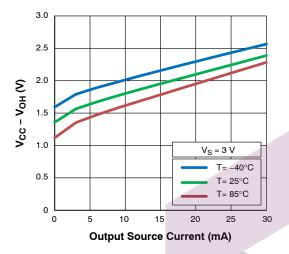


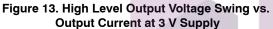
Figure 10. Input Offset Voltage vs. Common Mode Voltage at 5 V Supply





TYPICAL CHARACTERISTICS





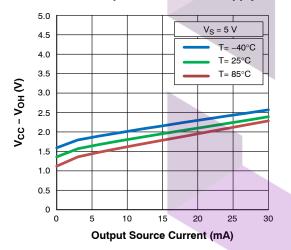
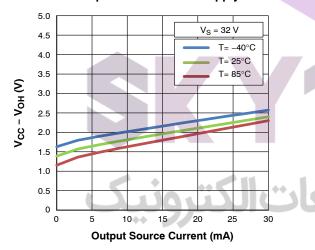
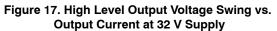


Figure 15. High Level Output Voltage Swing vs. Output Current at 5 V Supply





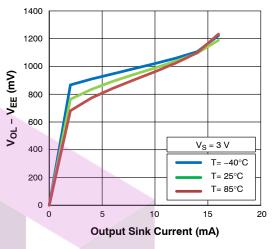


Figure 14. Low Level Output Voltage Swing vs. Output Current at 3 V Supply

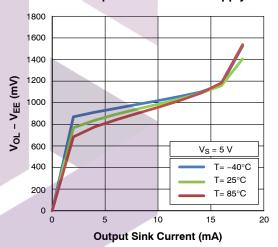
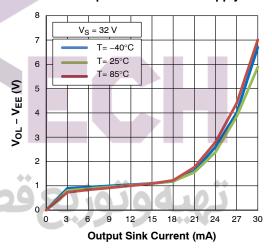
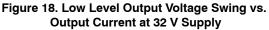


Figure 16. Low Level Output Voltage Swing vs. Output Current at 5 V Supply





APPLICATION INFORMATION

CIRCUIT DESCRIPTION

The LM321 is made using two internally compensated, two-stage operational amplifiers. The first stage of each consists of differential input devices Q20 and Q18 with input buffer transistors Q21 and Q17 and the differential to single ended converter Q3 and Q4. The first stage performs not only the first stage gain function but also performs the level shifting and transconductance reduction functions. By reducing the transconductance, a smaller compensation capacitor (only 5.0 pF) can be employed, thus saving chip area. The transconductance reduction is accomplished by splitting the collectors of Q20 and Q18. Another feature of this input stage is that the input common mode range can include the negative supply or ground, in single supply operation, without saturating either the input devices or the differential to single–ended converter. The second stage consists of a standard current source load amplifier stage.

Each amplifier is biased from an internal-voltage regulator which has a low temperature coefficient thus giving each amplifier good temperature characteristics as well as excellent power supply rejection.

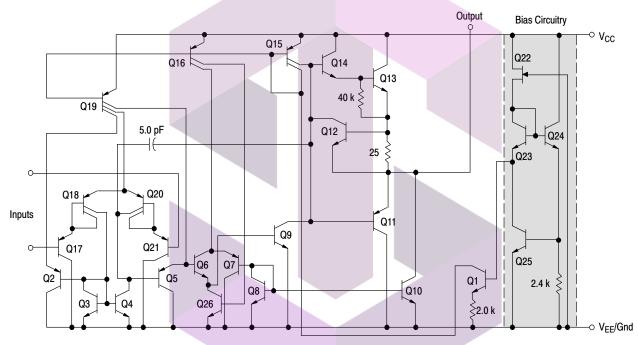
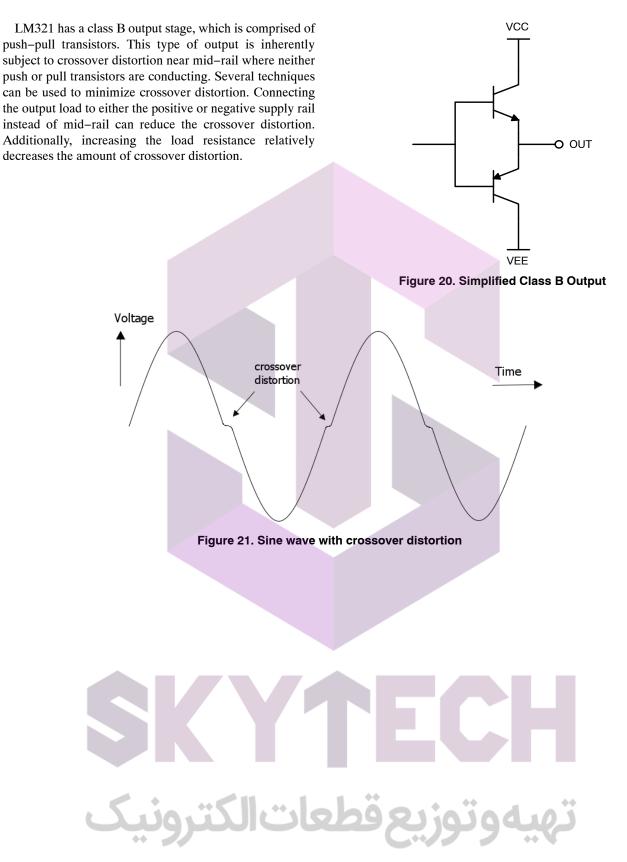
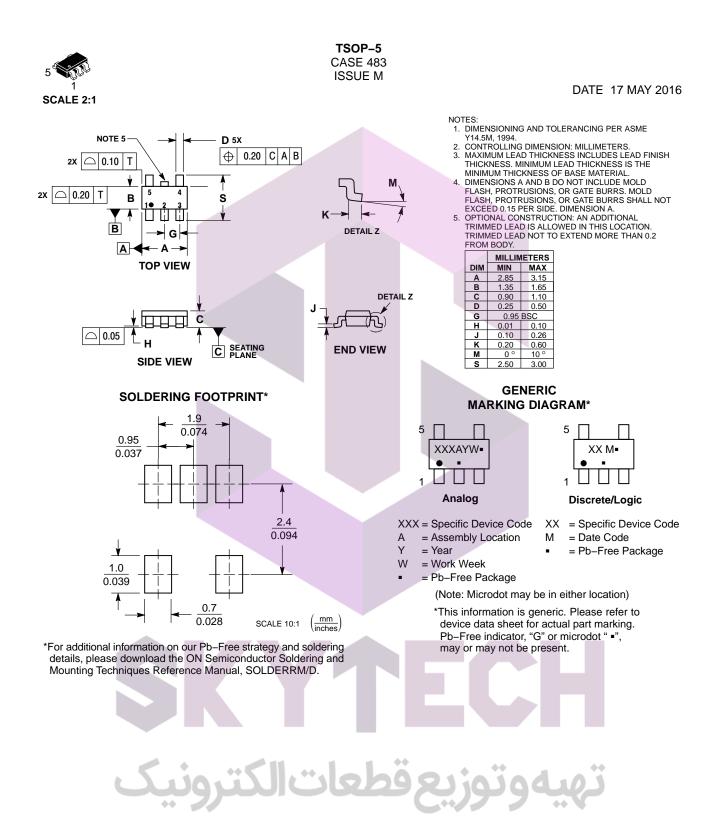


Figure 19. LM321 Representative Schematic Diagram









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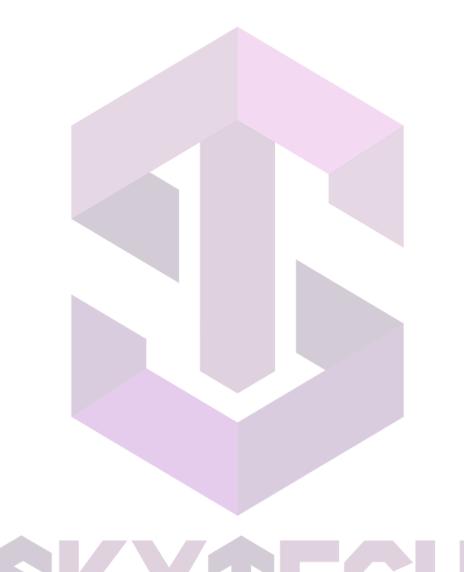
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|-------|---|-------------|
| ISSUE | REVISION | DATE |
| 0 | INITIATED NEW MECHANICAL OUTLINE #483. REQ BY WL CHIN/L. RENNICK. | 28 OCT 1998 |
| A | UPDATE OUTLINE DRAWING TO CORRECT DIN "C" (SHOULD BE FROM TIP OF LID TO TOP OF PKG). DIM IN TABLE INCORRECTLY LISTED TO G, F TO H, H TO J, N TO L & R TO M. REQ BY F. PADILLA | 13 NOV 1998 |
| В | CHANGE OF LEGAL ONWERSHIP FROM MOTOROLA TO ON SEMICONDUC- TOR. REQ BY A. GARLINGTON | 20 APR 2001 |
| С | ADDED NOTE "4". REQ BY S. RIGGS | 27 JUN 2003 |
| D | ADDED FOOTPRINT INFORMATION. UPDATED MARKING. REQ. BY D. JOERSZ | 07 APR 2005 |
| Е | CHANGED DEVICE MARKING FROM AWW TO AYW. REQ. BY J. MANES. | 14 SEP 2005 |
| F | UPDATED DRAWINGS TO LATEST JEDEC STANDARDS. ADDED NOTE 5. REQ. BY T. GURNETT. | 07 JUN 2006 |
| G | ADDED MARKING DIAGRAM FOR IC OPTION. REQ. BY J. MILLER. | 21 FEB 2007 |
| Н | CORRECTED MARKING DIAGRAM ERROR BY REVERSING ANALOG AND DISCRETE LABELS. REQ. BY GK SUA. | 18 MAY 2007 |
| J | CHANGED NOTE 4. REQ. BY A. GARLINGTON. | 13 MAR 2013 |
| К | REMOVED DIMENSION L AND ADDED DATUMS A AND B TO TOP VIEW. REQ. BY A. GARLINGTON. | 19 APR 2013 |
| L | REMOVED -02 FROM CASE CODE VARIANT. REQ. BY N. CALZADA. | 23 SEP 2015 |
| М | CHANGED DIMENSIONS A & B FROM BASIC TO MIN AND MAX VALUES. REQ. BY A. GARLINGTON. | 17 MAY 2016 |
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